64K (8K x 8)

**High Speed** 

E<sup>2</sup>PROM with

Page Write and

**Software Data** 

**Protection** 

**CMOS** 

#### 2

#### **Features**

- Fast Read Access Time 55 ns
- Automatic Page Write Operation

Internal Address and Data Latches for 64 Bytes

Fast Write Cycle Times

Page Write Cycle Time: 10 ms maximum 1 to 64 Byte Page Write Operation

- Low Power Dissipation
  - 40 mA Active Current

100 μA CMOS Standby Current

- Hardware and Software Data Protection
- DATA Polling and Toggle Bit for End of Write Detection
- High Reliability CMOS Technology

Endurance: 100,000 Cycles Data Retention: 10 years

- Single 5 V ± 10% Supply
- CMOS and TTL Compatible Inputs and Outputs
- JEDEC Approved Byte-Wide Pinout
- Full Military, Commercial, and Industrial Temperature Ranges

#### **Description**

The AT28HC64B is a high-performance electrically erasable and programmable read only memory (EEPROM). Its 64K of memory is organized as 8,192 words by 8 bits. Manufactured with Atmel's advanced nonvolatile CMOS technology, the device offers access times to 55 ns with power dissipation of just 220 mW. When the device is deselected, the CMOS standby current is less than  $100 \, \mu A$ .

The AT28HC64B is accessed like a Static RAM for the read or write cycle without the need for external components. The device contains a 64-byte page register to allow writing of up to 64 bytes simultaneously. During a write cycle, the addresses and 1 to 64 bytes of data are (continued)

## **Pin Configurations**

Pin Name	Function
A0 - A12	Addresses
CE	Chip Enable
ŌĒ	Output Enable
WE	Write Enable
1/00 - 1/07	Data Inputs/Outputs
NC	No Connect

TSOP Top View

	**	_				
	ŌĒ	Ħ	_	1	28 27 A10	CE
A11	A9	Ħ	2	3	26 *′ ₺ 1/07	
8A	NC	a	4	5	24 25 1/05	1/06
WE	vcc	3	6	-	23 🗖	1/04
NC		αv	8	′	21 1 20	GND
Α7	A12	뎜	10	9	20 19 E 1/O2	1/01
	A6	מטטטט	12	11	18 1 1/00	AO
A5	A4	ä	14	13	17 16 15 A1	
А3		۹_	14		15 15	A2

CERDIP,	PDIP	SOI
CLITDIE,	TOII,	300

Top View				
NC C 1 28 D VCC A12 C 2 70 WE A7 C 3 26 D NC A6 C 4 25 D A8 A5 C 5 24 D A9 A4 C 6 25 D GE A3 C 7 22 D GE A3 C 7				



Note: PLCC package pins 1 and 17 are DON'T CONNECT.



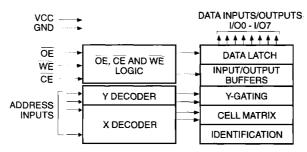


#### **Description** (Continued)

internally latched, freeing the address and data bus for other operations. Following the initiation of a write cycle, the device will automatically write the latched data using an internal control timer. The end of a write cycle can be detected by DATA Polling of I/O7. Once the end of a write cycle has been detected, a new access for a read or write can begin.

Atmel's AT28HC64B has additional features to ensure high quality and manufacturability. The device utilizes internal error correction for extended endurance and improved data retention. An optional software data protection mechanism is available to guard against inadvertent writes. The device also includes an extra 64 bytes of EEPROM for device identification or tracking.

#### **Block Diagram**



### **Absolute Maximum Ratings\***

Temperature Under Bias55°C	C to +125°C
Storage Temperature65°C	C to +150°C
All Input Voltages (including N.C. Pins) with Respect to Ground0.6 N	√ to +6.25 V
All Output Voltages with Respect to Ground0.6 V to	V <sub>CC</sub> +0.6 V
Voltage on OE and A9 with Respect to Ground0.6 \	√ to +13.5 V

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **Device Operation**

READ: The AT28HC64B is accessed like a Static RAM. When  $\overline{CE}$  and  $\overline{OE}$  are low and  $\overline{WE}$  is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high-impedance state when either  $\overline{CE}$  or  $\overline{OE}$  is high. This dual line control gives designers flexibility in preventing bus contention in their systems.

BYTE WRITE: A low pulse on the  $\overline{WE}$  or  $\overline{CE}$  input with  $\overline{CE}$  or  $\overline{WE}$  low (respectively) and  $\overline{OE}$  high initiates a write cycle. The address is latched on the falling edge of  $\overline{CE}$  or  $\overline{WE}$ , whichever occurs last. The data is latched by the first rising edge of  $\overline{CE}$  or  $\overline{WE}$ . Once a byte write has been started, it will automatically time itself to completion. Once a programming operation has been initiated and for the duration of  $t_{WC}$ , a read operation will effectively be a polling operation.

PAGE WRITE: The page write operation of the AT28HC64B allows one to 64 bytes of data to be written into the device during a single internal programming period. A page write operation is initiated in the same manner as a byte write; after the first byte is written, it can then be followed by one to 63 additional bytes. Each successive byte must be loaded within 150  $\mu s$  (tBLC) of the previous byte. If the tBLC limit is exceeded, the AT28HC64B will cease accepting data and commence the internal programming operation. All bytes during a page write operation must reside on the same page as defined by the state of the A6 to A12 inputs. For each  $\overline{WE}$  high to low transition during the page write operation, A6 to A12 must be the same.

The A0 to A5 inputs specify which bytes within the page are to be written. The bytes may be loaded in any order and may be altered within the same load period. Only bytes which are specified for writing will be written; unnecessary cycling of other bytes within the page does not occur.

DATA POLLING: The AT28HC64B features DATA Polling to indicate the end of a write cycle. During a byte or page write cycle, an attempted read of the last byte written will result in the complement of the written data to be presented on I/O7. Once the write cycle has been completed, true data is valid on all outputs, and the next write cycle may begin. DATA Polling may begin at any time during the write cycle.

TOGGLE BIT: In addition to DATA Polling, the AT28HC64B provides another method for determining the end of a write cycle. During the write operation, successive attempts to read data from the device will result in I/O6 toggling between one and zero. Once the write has completed, I/O6 will stop toggling, and valid data will be read. Toggle bit reading may begin at any time during the write cycle.

DATA PROTECTION: If precautions are not taken, inadvertent writes may occur during transitions of the host system power

supply. Atmel has incorporated both hardware and software features that will protect the memory against inadvertent writes.

HARDWARE DATA PROTECTION: Hardware features protect against inadvertent writes to the AT28HC64B in the following ways: (a)  $V_{CC}$  sense - if  $V_{CC}$  is below 3.8 V (typical), the write function is inhibited; (b)  $V_{CC}$  power-on delay - once  $V_{CC}$  has reached 3.8 V, the device will automatically time out 5 ms (typical) before allowing a write; (c) write inhibit - holding any one of  $\overline{OE}$  low,  $\overline{CE}$  high or  $\overline{WE}$  high inhibits write cycles; (d) noise filter - pulses of less than 15 ns (typical) on the  $\overline{WE}$  or  $\overline{CE}$  inputs will not initiate a write cycle.

SOFTWARE DATA PROTECTION: A software-controlled data protection feature has been implemented on the AT28HC64B. When enabled, the software data protection (SDP), will prevent inadvertent writes. The SDP feature may be enabled or disabled by the user; the AT28HC64B is shipped from Atmel with SDP disabled.

SDP is enabled by the user issuing a series of three write commands in which three specific bytes of data are written to three specific addresses (refer to the Software Data Protection Algorithm diagram in this data sheet). After writing the three-byte command sequence and waiting twc, the entire AT28HC64B will be protected against inadvertent writes. It should be noted that even after SDP is enabled, the user may still perform a byte or page write to the AT28HC64B. This is done by preceding the data to be written by the same three-byte command sequence used to enable SDP.

Once set, SDP remains active unless the disable command sequence is issued. Power transitions do not disable SDP, and SDP protects the AT28HC64B during power-up and power-down conditions. All command sequences must conform to the page write timing specifications. The data in the enable and disable command sequences is not actually written into the device; their addresses may still be written with user data in either a byte or page write operation.

After setting SDP, any attempt to write to the device without the three-byte command sequence will start the internal write timers. No data will be written to the device, however. For the duration of twc, read operations will effectively be polling operations.

DEVICE IDENTIFICATION: An extra 64 bytes of EEPROM memory are available to the user for device identification. By raising A9 to 12 V  $\pm$  0.5 V and using address locations 1FC0H to 1FFFH, the additional bytes may be written to or read from in the same manner as the regular memory array.

### Pin Capacitance $(f = 1 \text{ MHz}, T = 25^{\circ}\text{C})^{(1)}$

	_ <u>`</u>				
•		Тур	Max	Units	Conditions
CiN		4	6	pF	$V_{IN} = 0 V$
Соит		8	12	pF	V <sub>OUT</sub> = 0 V

Note: 1. This parameter is characterized and is not 100% tested.





#### D.C. and A.C. Operating Range

		AT28HC64B-55	AT28HC64B-70	AT28HC64B-90	AT28HC64B-120
	Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C	0°C - 70°C
Operating Temperature (Case)	Ind.		-40°C - 85°C	-40°C - 85°C	-40°C - 85°C
, , , , , , , , , , , , , , , , , , , ,	Mil.		-55°C - 125°C	-55°C - 125°C	-55°C - 125°C
Vcc Power Supply		5 V ± 10%	5 V ± 10%	5 V ± 10%	5 V ± 10%

## **Operating Modes**

Mode	CE	ŌĒ	WE	VO
Read	VIL	VIL	V <sub>1H</sub>	Dout
Write <sup>(2)</sup>	VIL	ViH	VIL	D <sub>IN</sub>
Standby/Write Inhibit	V <sub>IH</sub>	X <sup>(1)</sup>	X	High Z
Write Inhibit	Х	Х	ViH	
Write Inhibit	X	VIL	X	
Output Disable	Х	ViH	Х	High Z
Chip Erase	VıL	V <sub>H</sub> <sup>(3)</sup>	ViL	High Z

Notes: 1. X can be V<sub>IL</sub> or V<sub>IH</sub>.

2. Refer to the A.C. Write Waveforms diagrams in this data sheet.

3.  $V_H = 12.0 \text{ V} \pm 0.5 \text{ V}$ .

#### **D.C. Characteristics**

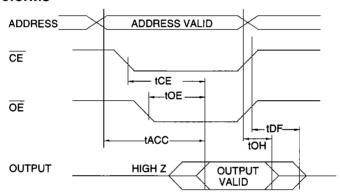
Symbol	Parameter	Condition		Min	Max	Units
l <sub>Ll</sub>	Input Load Current	VIN = 0 V to V <sub>CC</sub> + 1 V			10	μΑ
ILO	Output Leakage Current	$V_{I/O} = 0 V \text{ to } V_{CC}$			10	μА
Isa <sub>1</sub>	V <sub>CC</sub> Standby Current CMQS	CE= Vcc-0.3 V to Vcc + 1 V	Com., Ind.		100 <sup>(1)</sup>	μА
1981	VCC Startuby Current Civios	OE= VCC-0.3 V to VCC + 1 V	Mil.		200	μΑ
ISB2	Vcc Standby Current TTL	CE = 2.0 V to V <sub>CC</sub> + 1 V			2 <sup>(1)</sup>	mA
lcc	Vcc Active Current	$f = 5 \text{ MHz}$ ; $I_{OUT} = 0 \text{ mA}$			40	mA
VIL	Input Low Voltage				0.8	٧
VIH	Input High Voltage			2.0		٧
VoL	Output Low Voltage	loL = 2.1 mA			.40	٧
VoH	Output High Voltage	Юн = -400 μΑ		2.4		٧

Note: 1.  $I_{SB1}$  and  $I_{SB2}$  for the 55 ns part is 40 mA maximum.

#### A.C. Read Characteristics

		AT28H	C64B-55	AT28H	C64B-70	AT28H	C64B-90	AT28H0	64B-120	
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Min	Max	Units
tacc	Address to Output Delay		55		70		90		120	ns
tce (1)	CE to Output Delay		55		70		90		120	ns
toE (2)	OE to Output Delay	0	30	0	35	0	40	0	50	ns
t <sub>DF</sub> (3,4)	OE to Output Float	0	30	0	35	0	40	0	50	ns
tон	Output Hold	0		0		0		0		ns

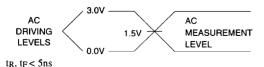
## A.C. Read Waveforms<sup>(1,2,3,4)</sup>



#### Notes:

- 1.  $\overline{\text{CE}}$  may be delayed up to  $t_{ACC}$   $t_{CE}$  after the address transition without impact on  $t_{ACC}$ .
- OE may be delayed up to t<sub>CE</sub> t<sub>OE</sub> after the falling edge of CE without impact on t<sub>CE</sub> or by t<sub>ACC</sub> - t<sub>OE</sub> after an address change without impact on t<sub>ACC</sub>.
- 3.  $t_{DF}$  is specified from  $\overline{OE}$  or  $\overline{CE},$  whichever occurs first (CL = 5 pF).
- 4. This parameter is characterized and is not 100% tested.

# Input Test Waveforms and Measurement Level



### **Output Test Load**

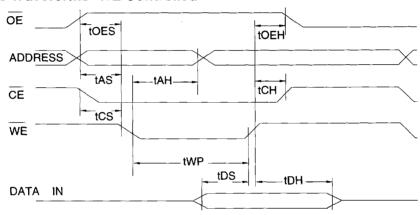




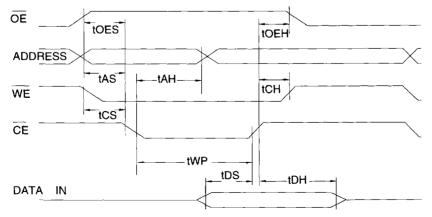
#### A.C. Write Characteristics

Symbol	Parameter	Min	Max	Units
tas, toes	Address, OE Set-up Time	0		ns
tan	Address Hold Time	50		ns
tcs	Chip Select Set-up Time	0		ns
tch	Chip Select Hold Time	0		ns
twp	Write Pulse Width (WE or CE)	100		ns
tos	Data Set-up Time	50		ns
tDH,tOEH	Data, OE Hold Time	0		ns

## A.C. Write Waveforms- WE Controlled



## A.C. Write Waveforms- CE Controlled

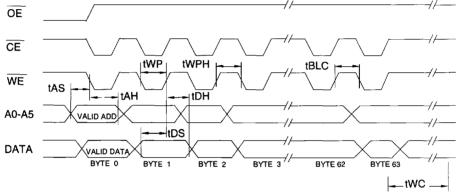


AT28HC64B

#### **Page Mode Characteristics**

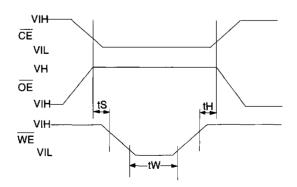
Symbol	Parameter	Min	Max	Units
twc	Write Cycle Time		10	ms
tas	Address Set-up Time	0	***	ns
tah	Address Hold Time	50		ns
t <sub>DS</sub>	Data Set-up Time	50		ns
toH	Data Hold Time	0		ns
twp	Write Pulse Width	100		ns
tBLC	Byte Load Cycle Time		150	μs
twph	Write Pulse Width High	50		ns

## Page Mode Write Waveforms<sup>(1,2)</sup>



Notes: 1. A6 through A12 must specify the same page address during each high to low transition of  $\overline{WE}$  (or  $\overline{CE}$ ). 2.  $\overline{OE}$  must be high only when  $\overline{WE}$  and  $\overline{CE}$  are both low.

## **Chip Erase Waveforms**

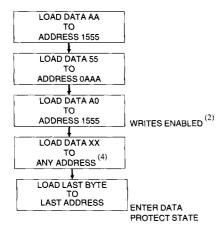


 $t_S = t_H = 5 \mu sec (min.)$   $t_W = 10 msec (min.)$  $V_H = 12.0 V \pm 0.5 V$ 





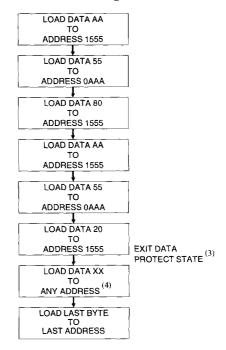
# Software Data Protection Enable Algorithm (1)



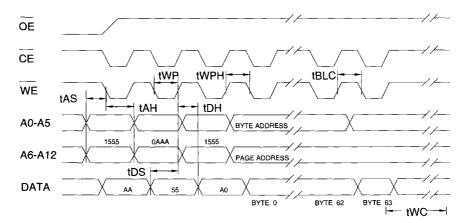
Notes for software program code:

- 1. Data Format: I/O7 I/O0 (Hex); Address Format: A12 - A0 (Hex).
- Write Protect state will be activated at end of write even if no other data is loaded.
- 3. Write Protect state will be deactivated at end of write period even if no other data is loaded.
- 4. 1 to 64 bytes of data are loaded.

# Software Data Protection Disable Algorithm (1)



## Software Protected Write Cycle Waveforms<sup>(1,2)</sup>



Notes: 1. A6 through A12 must specify the same page address during each high to low transition of  $\overline{\text{WE}}$  (or  $\overline{\text{CE}}$ ) after the software code has been entered.

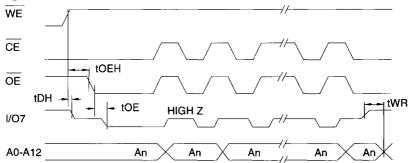
2.  $\overline{OE}$  must be high only when  $\overline{WE}$  and  $\overline{CE}$  are both low.

## Data Polling Characteristics(1)

Symbol	Parameter	Min	Тур	Max	Units
tDH	Data Hold Time	0			ns
toeh	OE Hold Time	0			ns
toe	OE to Output Delay <sup>(2)</sup>				ns
twn	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested. 2. See A.C. Read Characteristics.

## **Data** Polling Waveforms



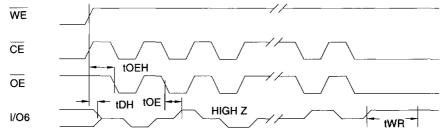
## Toggle Bit Characteristics(1)

Symbol	Parameter	Min	Тур	Max	Units	
ton	Data Hold Time	10			ns	
toeh	OE Hold Time	10		<u> </u>	ns	
toe	OE to Output Delay <sup>(2)</sup>				ns	
toehp	OE High Pulse	150			ns	
twn	Write Recovery Time	0			ns	

Notes: 1. These parameters are characterized and not 100% tested.

2. See A.C. Read Characteristics.

## Toggle Bit Waveforms (1,2,3)



Notes: 1. Toggling either  $\overline{OE}$  or  $\overline{CE}$  or both  $\overline{OE}$  and  $\overline{CE}$  will operate toggle bit.

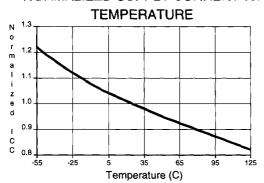
2. Beginning and ending state of I/O6 will vary.

3. Any address location may be used, but the address should not vary.

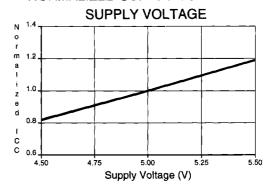




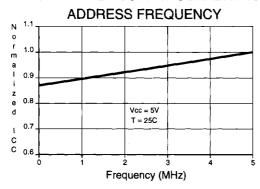
#### NORMALIZED SUPPLY CURRENT vs.



#### NORMALIZED SUPPLY CURRENT vs.



#### NORMALIZED SUPPLY CURRENT vs.



## Ordering Information<sup>(1)</sup>

tacc (ns)	ICC (mA) Active Standby		Ordering Code	Package	Operation Range	
55	40	0.1	AT28HC64B-55DC AT28HC64B-55JC AT28HC64B-55PC AT28HC64B-55SC	28D6 32J 28P6 28S	Commercial (0°C to 70°C)	
70	40	0.1	AT28HC64B-70DC AT28HC64B-70JC AT28HC64B-70PC AT28HC64B-70SC AT28HC64B-70TC	28D6 32J 28P6 28S 28T	Commercial (0°C to 70°C)	
			AT28HC64B-70DI AT28HC64B-70JI AT28HC64B-70PI AT28HC64B-70SI AT28HC64B-70TI	28D6 32J 28P6 28S 28T	Industrial (-40°C to 85°C)	
70	40	0.2	AT28HC64B-70DM/883	28D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)	
90	90 40	0.1	AT28HC64B-90DC AT28HC64B-90JC AT28HC64B-90PC AT28HC64B-90SC AT28HC64B-90TC	28D6 32J 28P6 28S 28T	Commercial (0°C to 70°C)	
			AT28HC64B-90DI AT28HC64B-90JI AT28HC64B-90PI AT28HC64B-90SI AT28HC64B-90TI	28D6 32J 28P6 28S 28T	Industrial (-40°C to 85°C)	
90	40	0.2	AT28HC64B-90DM/883	28D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)	
120	40	0.1	AT28HC64B-120DC AT28HC64B-120JC AT28HC64B-120PC AT28HC64B-120SC AT28HC64B-120TC	28D6 32J 28P6 28S 28T	Commercial (0°C to 70°C)	
			AT28HC64B-120DI AT28HC64B-120JI AT28HC64B-120PI AT28HC64B-120SI AT28HC64B-120TI	28D6 32J 28P6 28S 28T	Industrial (-40°C to 85°C)	
120	40	0.2	AT28HC64B-120DM/883	28D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)	





## **Ordering Information**

tacc (ns)	Icc (mA)		Ordering Code	Package	Operation Range
	Active Standby			- donago	
70	40	0.2	5962-87514 12 XX	28D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)
90	40	0.2	5962-87514 11 XX	28D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)
1200	40	0.2	5962-87514 10 XX	28D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)

Note: 1. See Valid Part Number table below.

#### **Valid Part Numbers**

The following table lists standard Atmel products that can be ordered.

Device Numbers	Speed	Package and Temperature Combinations
AT28HC64B	55	DC, JC, PC, SC
AT28HC64B	70	DC, DI, JC, JI, PC, PI, SC, SI, TC, TI, DM/883
AT28HC64B	90	DC, DI, JC, JI, PC, PI, SC, SI, TC, TI, DM/883
AT28HC64B	12	DC, DI, JC, JI, PC, PI, SC, SI, TC, TI, DM/883

Package Type					
28D6	28 Lead, 0.600" Wide, Non-Windowed Ceramic Dual Inline Package (Cerdip)				
32J	32 Lead, Plastic J-Leaded Chip Carrier (PLCC)				
28P6	28 Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)				
28S	28 Lead, 0.300" Wide, Plastic Gull Wing Small Outline (SOIC)				
28T	28 Lead, Plastic Thin Small Outline Package (TSOP)				

AT28HC64B \_\_\_\_